ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® MALECTRONICS INDUSTRIES®	, Bannockb	urn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declara	tion of the sencompass	substances es all lowe	within the mar	ufacturer li s for which	isted item. Note:	f the item is an a r has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distril								Materials a	ials and Mfg Information				
Supplier Information														
Company name* Compa			ompany unique ID			Unique ID Authority					Response Date*			
onsemi										20	2025-06-04			
ntact Name Title - Contact				Phone - Contact*				En	Email - Contact*					
Product-Env-Stewards Product Envir			viro Compliance			NA				P	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representati			entative I		Phone - Representative*			En	Email - Representative*					
Product-Env-Stewards Product			Product Enviro Compliance			NA				P	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Da	e Versior	1	Manufacturing Site		Weight*	UOM	Unit Type	
	NTZD31	NTZD3155CT2G COMP SOT56		53 20V 540MA TR		2025-06-04		MY1		2.72	mg	Each		
Aanufacturing Proccess Informatio	n											-		
Terminal Plating / Grid Array Mater	terial Terminal Base Alloy		Alloy	J-STD-020 MSI	MSL Rating Pe		ak Process Body Temperature Max Time at Peak		at Peak Ten	Temperature Number of Reflow Cycles		cles		
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30		seconds 3				
omments														
vel 1 - maximum time at peak temperature	during sol	dering is 10-3	0 seconds											
or more information regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.06	mg	Supplier	Silicon (Si)	7440-21-3		0.06	mg	
Lead Frame	1.18	mg	Supplier	Silver (Ag)	7440-22-4		0.21	mg	
			В	Nickel (Ni)	7440-02-0		0.3646	mg	
			Supplier	Iron (Fe)	7439-89-6		0.5039	mg	
			Supplier	Copper (Cu)	7440-50-8		0.1015	mg	
Mold Compound-Black	1.4	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.14	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.007	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.203	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.91	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.14	mg	
Plating	0.06	mg	Supplier	Tin (Sn)	7440-31-5		0.06	mg	
Wire Bond - Cu	0.02	mg	Supplier	Copper (Cu)	7440-50-8		0.02	mg	